

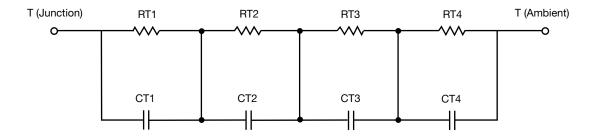
R-C Thermal Model Parameters

DESCRIPTION

The parametric values in the R-C thermal model have been derived using curve-fitting techniques. R-C values for the electrical circuit in the Foster/tank and Cauer/filter configurations are included. When implemented in P-SPICE, these values have matching characteristic curves to the single-pulse transient thermal impedance curves for the MOSFET.

These RC values can be used in the P-SPICE simulation to evaluate the thermal behavior of the MOSFET junction temperature under a defined power profile. These techniques are described in application note AN609, "Thermal Simulation of Power MOSFETs on the P-SPICE Platform".

R-C THERMAL MODEL FOR TANK CONFIGURATION



THERMAL RESISTANCE (°C/W)					
Junction to	Ambient	Case	Foot		
RT1	n/a	46.1657m	n/a		
RT2	n/a	79.3411m	n/a		
RT3	n/a	58.9292m	n/a		
RT4	n/a	115.5640m	n/a		
	THERMAL CAPAC	ITANCE (Joules/°C)			
Junction to	Ambient	Case	Foot		
CT1	n/a	995.3079m	n/a		
CT2	n/a	573.2441m	n/a		
CT3	n/a	93.9680m	n/a		
CT4	n/a	5.2389m	n/a		

Note

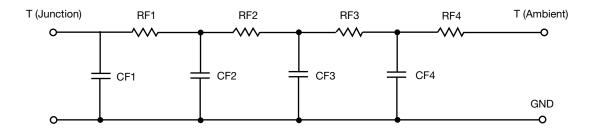
• n/a indicates not applicable

This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

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R-C THERMAL MODEL FOR FILTER CONFIGURATION



THERMAL RESISTANCE (°C/W)						
Junction to	Ambient	Case	Foot			
RF1	n/a	133.3755m	n/a			
RF2	n/a	72.7442m	n/a			
RF3	n/a	61.3480m	n/a			
RF4	n/a	32.5323m	n/a			
	THERMAL CAPAC	ITANCE (Joules/°C)				
Junction to	Ambient	Case	Foot			
CF1	n/a	4.9561m	n/a			
CF2	n/a	88.2375m	n/a			
CF3	n/a	344.7316m	n/a			
CF4	n/a	122.0071m	n/a			

Note

• n/a indicates not applicable

